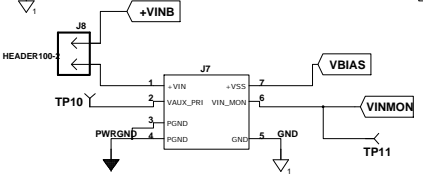
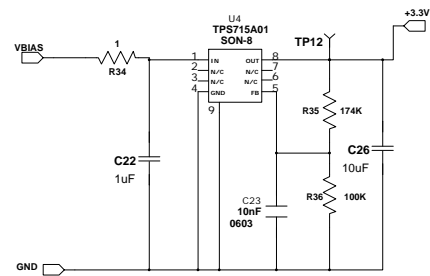
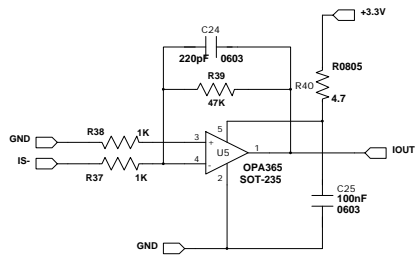


Pins	Description
1	VOUT
2	IOUT
3	VINMON
4,7	GND
5	VDD
11	OUTA
9	OUTB
6	OUTE
8	OUTF
10	OUTC
12	OUTD
14	SYNC
13	CS



Texas Instruments			
Title C2000 600W HVPSFB EVM			
Size C	Number HVPSFB	Rev A	
Date Thu Dec 16, 2010	Drawn by H. Nene	Sheet 1 of 1	
Filename HVPSFB_RevA.sch		Engineer H. Nene	



Texas Instruments

Title		
C2000 600W HVPSFB EVM		
Size	Number	Rev
C	HVPSFB	A
Date	Thu Dec 16, 2010	Drawn by H. Nene
Filename	HVPSFB_RevA.sch	Sheet 1 of 1

14 SYNC  
13 CS

Engineer H. Nene

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